

LM741-MIL Operational Amplifier

1 Features

- Overload Protection on the Input and Output
- No Latch-Up When the Common-Mode Range is Exceeded

2 Applications

- Comparators
- Multivibrators
- DC Amplifiers
- Summing Amplifiers
- Integrator or Differentiators
- Active Filters

3 Description

The LM741-MIL is a general-purpose operational amplifier which features improved performance over industry standards such as the LM709. It is a direct, plug-in replacement for the 709C, LM201, MC1439, and 748 in most applications.

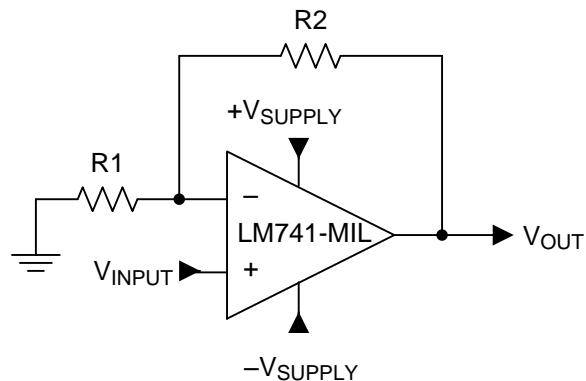
The amplifier offers many features which make applications nearly foolproof such as overload protection on the input and output, no latch-up when the common-mode range is exceeded, and freedom from oscillations.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
LM741-MIL	TO-99 (8)	9.08 mm × 9.08 mm
	CDIP (8)	10.16 mm × 6.502 mm
	PDIP (8)	9.81 mm × 6.35 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Simplified Application



Copyright © 2017, Texas Instruments Incorporated



Table of Contents

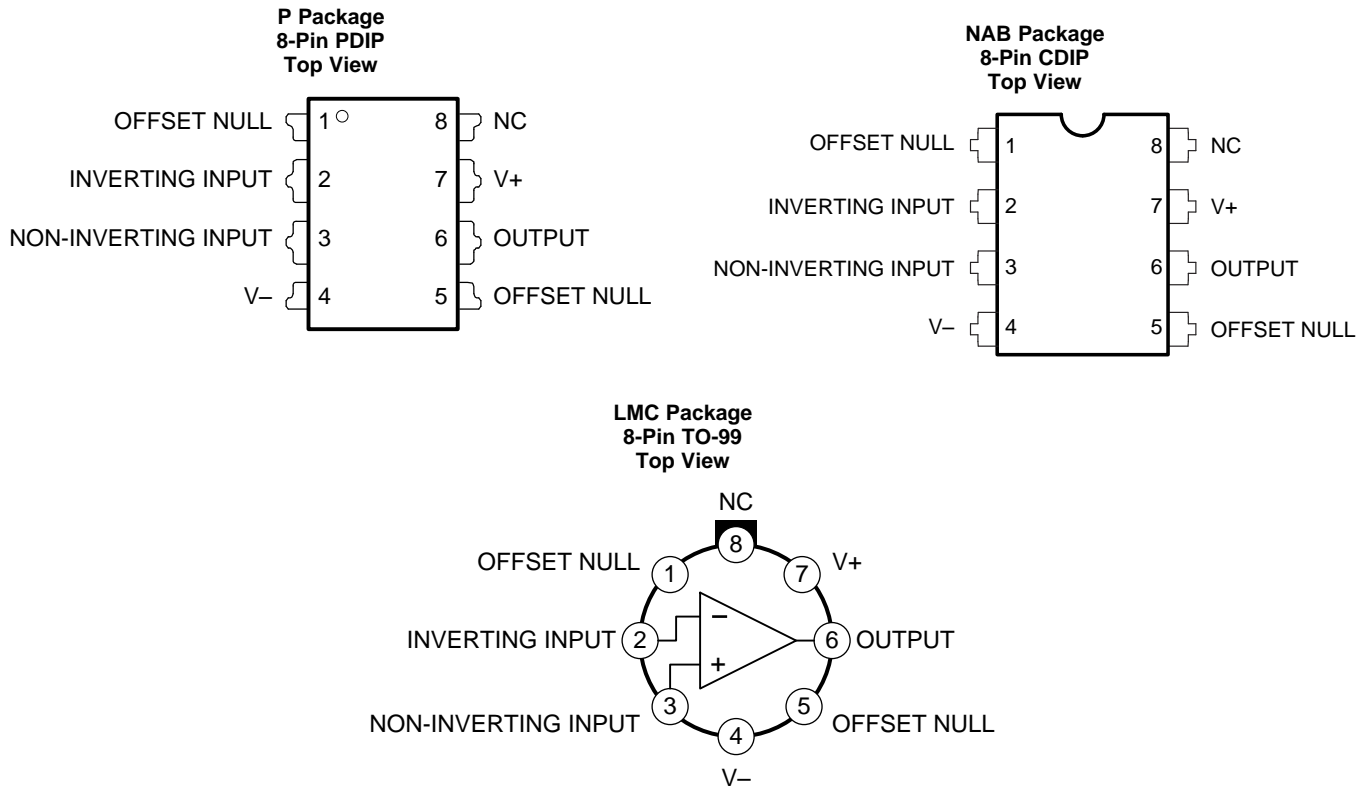
1 Features	1	7.4 Device Functional Modes.....	7
2 Applications	1	8 Application and Implementation	8
3 Description	1	8.1 Application Information.....	8
4 Revision History	2	8.2 Typical Application	8
5 Pin Configuration and Functions	3	9 Power Supply Recommendations	9
6 Specifications	4	10 Layout	9
6.1 Absolute Maximum Ratings	4	10.1 Layout Guidelines	9
6.2 ESD Ratings.....	4	10.2 Layout Example	9
6.3 Recommended Operating Conditions.....	4	11 Device and Documentation Support	10
6.4 Thermal Information	4	11.1 Receiving Notification of Documentation Updates	10
6.5 Electrical Characteristics.....	5	11.2 Community Resources.....	10
7 Detailed Description	6	11.3 Trademarks	10
7.1 Overview	6	11.4 Electrostatic Discharge Caution.....	10
7.2 Functional Block Diagram	6	11.5 Glossary	10
7.3 Feature Description.....	6	12 Mechanical, Packaging, and Orderable Information	10

4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	REVISION	NOTES
June 2017	*	Initial release.

5 Pin Configuration and Functions



Pin Functions

PIN		I/O	DESCRIPTION
NAME	NO.		
INVERTING INPUT	2	I	Inverting signal input
NC	8	N/A	No Connect, leave floating
NONINVERTING INPUT	3	I	Noninverting signal input
OFFSET NULL	1	I	Offset null pin used to eliminate the offset voltage and balance the input voltages.
OFFSET NULL	5		
OUTPUT	6	O	Amplified signal output
V+	7	I	Positive supply voltage
V-	4	I	Negative supply voltage

6 Specifications

6.1 Absolute Maximum Ratings

 over operating free-air temperature range (unless otherwise noted) ⁽¹⁾⁽²⁾⁽³⁾

	MIN	MAX	UNIT
Supply voltage		±22	V
Power dissipation ⁽⁴⁾		500	mW
Differential input voltage		±30	V
Input voltage ⁽⁵⁾		±15	V
Output short circuit duration		Continuous	
Operating temperature	–50	125	°C
Junction temperature, T _{J(max)}		150	°C
Storage temperature, T _{stg}	–65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those specified in the [Recommended Operating Conditions](#) table. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) For military specifications see RETS741X for LM741-MIL and RETS741AX for LM741-MILA.
- (3) If Military/Aerospace specified devices are required, please contact the TI Sales Office/Distributors for availability and specifications.
- (4) For operation at elevated temperatures, these devices must be derated based on thermal resistance, and T_{J(max)}. (listed in the [Absolute Maximum Ratings](#) table). $T_j = T_A + (\theta_{JA} \times P_D)$.
- (5) For supply voltages less than ±15 V, the absolute maximum input voltage is equal to the supply voltage.

6.2 ESD Ratings

	VALUE	UNIT
V _(ESD) Electrostatic discharge Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±400	V

- (1) Level listed above is the passing level per ANSI, ESDA, and JEDEC JS-001. JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

	MIN	NOM	MAX	UNIT
Supply voltage (VDD-GND)	±10	±15	±22	V
Temperature	–55		125	°C

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾	LM741-MIL			UNIT
	LMC (TO-99)	NAB (CDIP)	P (PDIP)	
	8 PINS	8 PINS	8 PINS	
R _{θJA} Junction-to-ambient thermal resistance	170	100	100	°C/W
R _{θJC(top)} Junction-to-case (top) thermal resistance	25	—	—	°C/W

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

6.5 Electrical Characteristics

 $V_S = \pm 15\text{ V}$, $-55^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$ (unless otherwise specified)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
Input offset voltage		$R_S \leq 10\text{ k}\Omega$	$T_A = 25^\circ\text{C}$		1	5	mV
						6	mV
Input offset voltage adjustment range		$T_A = 25^\circ\text{C}$, $V_S = \pm 20\text{ V}$			± 15		mV
Input offset current		$T_A = 25^\circ\text{C}$			20	200	nA
					85	500	
Input bias current		$T_A = 25^\circ\text{C}$			80	500	nA
						1.5	μA
Input resistance		$T_A = 25^\circ\text{C}$, $V_S = \pm 20\text{ V}$		0.3	2		M Ω
Input voltage range				± 12	± 13		V
Large signal voltage gain		$V_S = \pm 15\text{ V}$, $V_O = \pm 10\text{ V}$, $R_L \geq 2\text{ k}\Omega$	$T_A = 25^\circ\text{C}$	50	200		V/mV
				25			
Output voltage swing		$V_S = \pm 15\text{ V}$	$R_L \geq 10\text{ k}\Omega$	± 12	± 14		V
			$R_L \geq 2\text{ k}\Omega$	± 10	± 13		
Output short circuit current		$T_A = 25^\circ\text{C}$			25		mA
Common-mode rejection ratio		$R_S \leq 10\text{ }\Omega$, $V_{CM} = \pm 12\text{ V}$		80	95		dB
Supply voltage rejection ratio		$V_S = \pm 20\text{ V}$ to $V_S = \pm 5\text{ V}$, $R_S \leq 10\text{ }\Omega$		86	96		dB
Transient response	Rise time	$T_A = 25^\circ\text{C}$, unity gain			0.3		μs
	Overshoot				5%		
Slew rate		$T_A = 25^\circ\text{C}$, unity gain			0.5		V/ μs
Supply current		$T_A = 25^\circ\text{C}$			1.7	2.8	mA
Power consumption		$V_S = \pm 15\text{ V}$	$T_A = 25^\circ\text{C}$		50	85	mW
			$T_A = T_{A(\text{min})}$		60	100	
			$T_A = T_{A(\text{min})}$		45	75	

7.4 Device Functional Modes

7.4.1 Open-Loop Amplifier

The LM741-MIL can be operated in an open-loop configuration. The magnitude of the open-loop gain is typically large thus for a small difference between the non-inverting input terminals and the inverting input terminals, the amplifier output is driven near the supply voltage. Without negative feedback, the LM741-MIL can act as a comparator. If the inverting input is held at 0 V, and the input voltage applied to the non-inverting input is positive, the output will be positive. If the input voltage applied to the non-inverting input is negative, the output is negative.

7.4.2 Closed-Loop Amplifier

In a closed-loop configuration, negative feedback is used by applying a portion of the output voltage to the inverting input. Unlike the open-loop configuration, closed loop feedback reduces the gain of the circuit. The overall gain and response of the circuit is determined by the feedback network rather than the operational amplifier characteristics. The response of the operational amplifier circuit is characterized by the transfer function.

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The LM741-MIL is a general-purpose amplifier that can be used in a variety of applications and configurations. One common configuration is in a non-inverting amplifier configuration. In this configuration, the output signal is in phase with the input (not inverted as in the inverting amplifier configuration), the input impedance of the amplifier is high, and the output impedance is low. The characteristics of the input and output impedance is beneficial for applications that require isolation between the input and output. No significant loading will occur from the previous stage before the amplifier. The gain of the system is set accordingly so the output signal is a factor larger than the input signal.

8.2 Typical Application

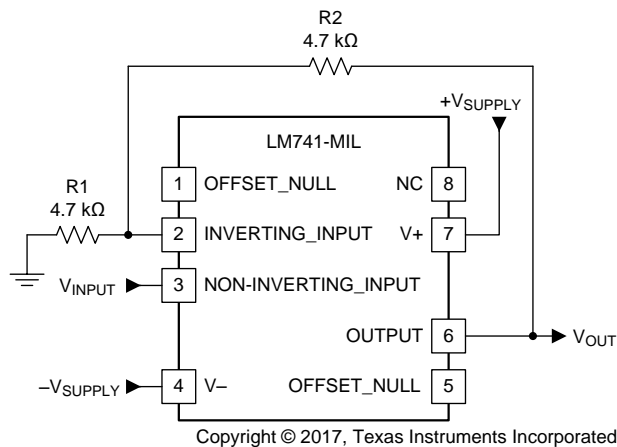


Figure 1. LM741-MIL Noninverting Amplifier Circuit

8.2.1 Design Requirements

As shown in [Figure 1](#), the signal is applied to the noninverting input of the LM741-MIL. The gain of the system is determined by the feedback resistor and input resistor connected to the inverting input. The gain can be calculated by [Equation 1](#):

$$\text{Gain} = 1 + (R2/R1) \quad (1)$$

The gain is set to 2 for this application. R1 and R2 are 4.7-kΩ resistors with 5% tolerance.

8.2.2 Detailed Design Procedure

The LM741-MIL can be operated in either single supply or dual supply. This application is configured for dual supply with the supply rails at ±15 V. The input signal is connected to a function generator. A 1-V_{PP}, 10-kHz sine wave was used as the signal input. 5% tolerance resistors were used, but if the application requires an accurate gain response, use 1% tolerance resistors.

8.2.3 Application Curve

The waveforms in [Figure 2](#) show the input and output signals of the LM741-MIL non-inverting amplifier circuit. The blue waveform (top) shows the input signal, while the red waveform (bottom) shows the output signal. The input signal is 1.06 V_{P-P} and the output signal is 1.94 V_{P-P}. With the 4.7-kΩ resistors, the theoretical gain of the system is 2. Due to the 5% tolerance, the gain of the system including the tolerance is 1.992. The gain of the system when measured from the mean amplitude values on the oscilloscope was 1.83.

Typical Application (continued)

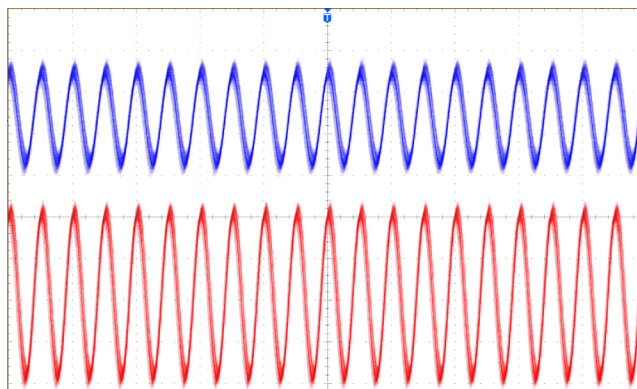


Figure 2. Waveforms for LM741-MIL Non-inverting Amplifier Circuit

9 Power Supply Recommendations

For proper operation, the power supplies must be properly decoupled. For decoupling the supply lines, a 0.1- μ F capacitor is recommended and should be placed as close as possible to the LM741-MIL power supply pins.

10 Layout

10.1 Layout Guidelines

As with most amplifiers, take care with lead dress, component placement, and supply decoupling in order to ensure stability. For example, resistors from the output to an input should be placed with the body close to the input to minimize pick-up and maximize the frequency of the feedback pole by minimizing the capacitance from the input to ground. As shown in Figure 3, the feedback resistors and the decoupling capacitors are located close to the device to ensure maximum stability and noise performance of the system.

10.2 Layout Example

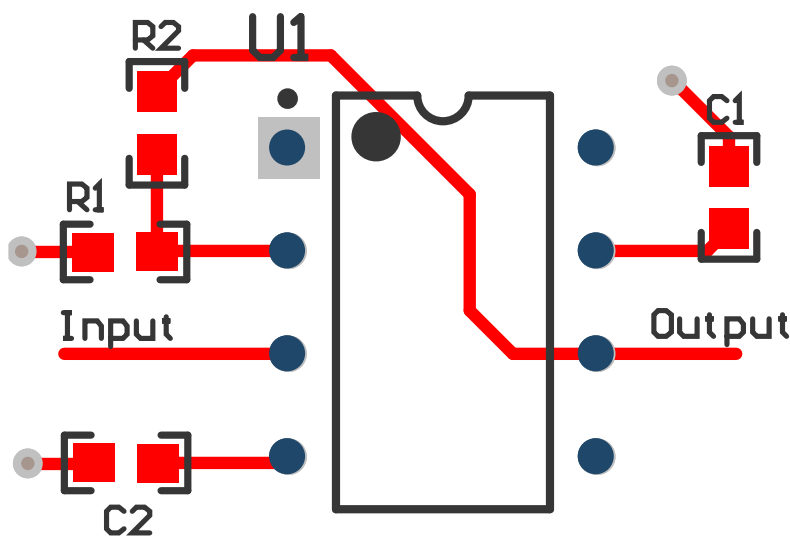


Figure 3. LM741-MIL Layout

11 Device and Documentation Support

11.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

11.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.3 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

11.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM741CH	Active	Production	TO-99 (LMC) 8	500 OTHER	No	Call TI	Level-1-NA-UNLIM	0 to 70	(LM741CH, LM741CH)
LM741CH/NOPB	Active	Production	TO-99 (LMC) 8	500 OTHER	Yes	Call TI	Level-1-NA-UNLIM	0 to 70	(LM741CH, LM741CH)
LM741H	Active	Production	TO-99 (LMC) 8	500 OTHER	No	Call TI	Level-1-NA-UNLIM	-55 to 125	(LM741H, LM741H)
LM741H/NOPB	Active	Production	TO-99 (LMC) 8	500 OTHER	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	(LM741H, LM741H)
LM741J	Active	Production	CDIP (NAB) 8	40 TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM741J
U5B7741312	Active	Production	TO-99 (LMC) 8	500 OTHER	No	Call TI	Level-1-NA-UNLIM	-55 to 125	(LM741H, LM741H)
U5B7741393	Active	Production	TO-99 (LMC) 8	500 OTHER	No	Call TI	Level-1-NA-UNLIM	0 to 70	(LM741CH, LM741CH)

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

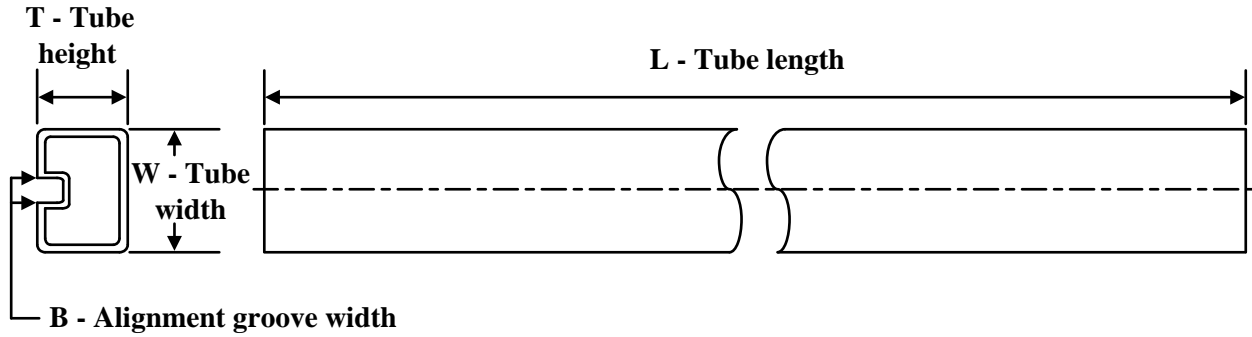
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative

and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

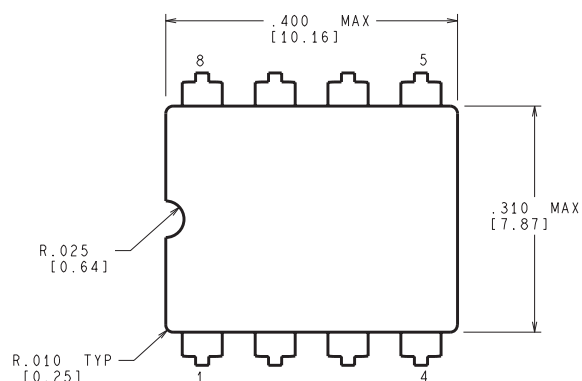
TUBE



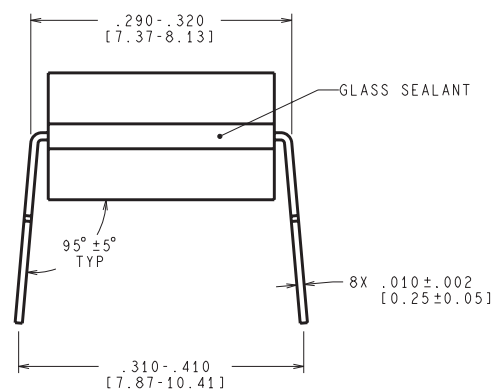
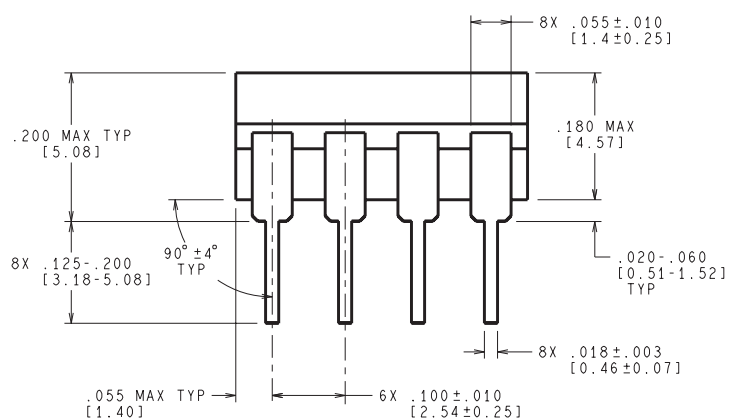
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
LM741J	NAB	CDIP	8	40	502	14	11938	4.32

NAB0008A



CONTROLLING DIMENSION IS INCH
VALUES IN [] ARE MILLIMETERS



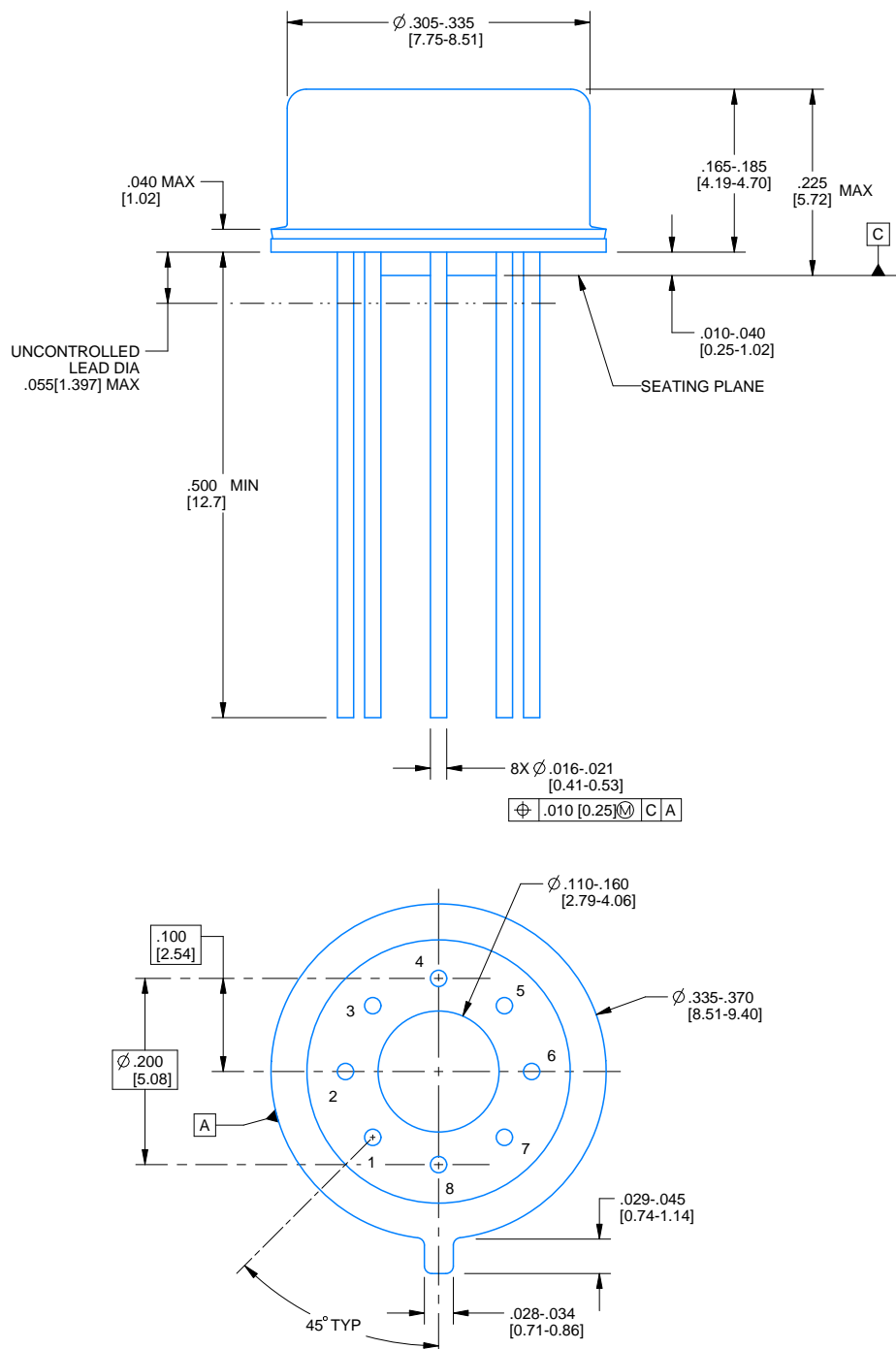
J08A (Rev M)

PACKAGE OUTLINE

LMC0008A

TO-CAN - 5.72 mm max height

TRANSISTOR OUTLINE



4220610/B 09/2024

NOTES:

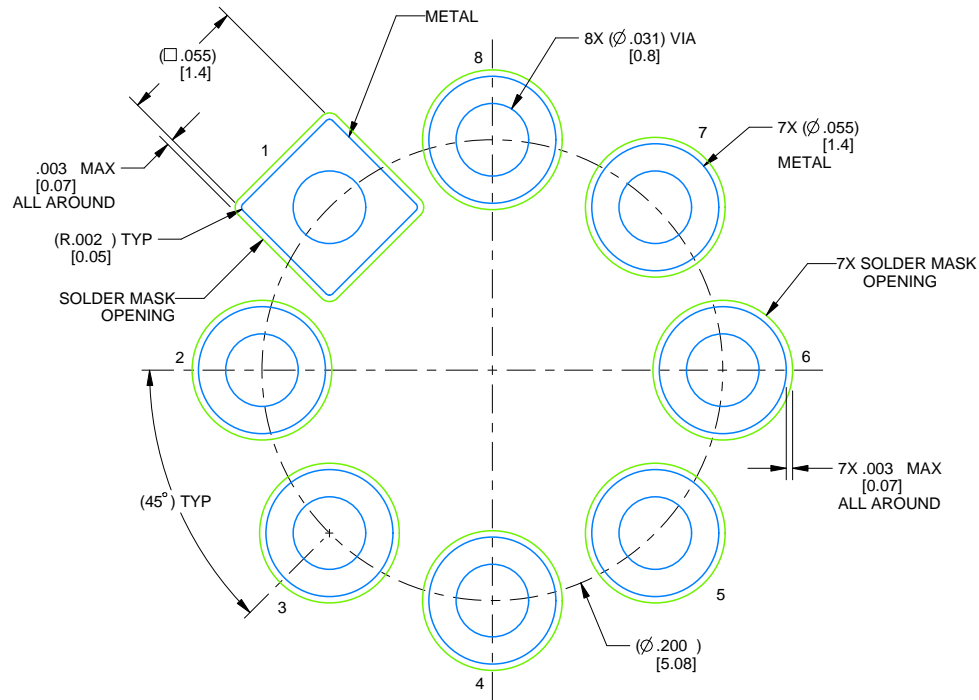
1. All linear dimensions are in inches [millimeters]. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Pin numbers shown for reference only. Numbers may not be marked on package.
4. Reference JEDEC registration MO-002/TO-99.

EXAMPLE BOARD LAYOUT

LMC0008A

TO-CAN - 5.72 mm max height

TRANSISTOR OUTLINE



LAND PATTERN EXAMPLE
NON-SOLDER MASK DEFINED
SCALE: 12X

4220610/B 09/2024

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on [ti.com](#) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2026, Texas Instruments Incorporated

Last updated 10/2025